3M Scotch-Weld[™] Structural Adhesive Film AF 42 • AF 46

Technical Data	Issue No. 3
Introduction	3M [™] Scotch-Weld [™] Structural Adhesive Films AF 42 and AF 46 are unsupported, thermosetting film adhesives designed for the structural bonding of metals and glass.
Advantages	Excellent adhesion to metal and glass
	• High shear, peel, and cleavage strengths over a wide temperature range
	• High degree of film clarity when in contact with a solid surface
	• Flexible cure cycles
	• Lightweight and easy to handle
	• AF 46 is 1 mil thick version of AF 42
	• AF 3542 is 3.5 mil thick AF 42
	Relatively low bonding pressures may be used
	• Low tack
	• Low flow

Description

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Product		AF 42	AF 3542	AF 42	AF 42	AF 46
Weight	lb/ft ²	.020 ± .005	.021 ± .003	.040 ± .005	.040 ± .005	.006 ± .0015
	g/m²	98 ± 24.5	103 ± 14.7	196 ± 24.5	196 ± 24.5	29.3 ± 7.3
Thickness	mils	3	3.5	6	6	1
	micrometers	76.2	88.9	152.4	152.4	25.4
Color		Clear	Clear	Clear	Black	Clear

I. Electrical Properties

Dissipation Factor at 73.4°F (23°C)					
	100Hz	1kHz	10kHz	100kHz	1MHz
AF 42 (3 mil)	0.196	0.111	0.089	0.073	0.061
Dielectric Constant at 73.4°F (23°C)	-	•			
	100Hz	1kHz	10kHz	100kHz	1MHz
AF 42 (3 mil)	—	6.1	5.3	4.7	4.3
			AF 42		
Dielectric Strength (ASTM D149)	1430 Volts/mil				
Volume Resistivity (ASTM D257)	2.6 x 10 ¹² ohm/cm				
Electrical Corrosion to Copper (ASTM D3482)	Pass				
Arc Resistance	64 sec				
Surface Resistivity (500 Volts - DC)	4.1 x 10 ¹³ ohm/square				

II. Thermal Properties

			AF	42		
Glass Transition Temperature (by heating DSC with heating rate of 20°C/min (36°F/min). Second heat values given.		66.2°F (19°C)				
Thermal Conductivity (btu-ft/ft ² -hr °F) ASTM C177		.124 at 44°C				
Thermal Coefficient of Expansion (in/in/°C) (by TMA at 5°C/min.) Second heat values given.		117 x 10 ⁻⁶ (0°C to 80°C)				
Hardness - Shore D (ASTM D2240)	76					
Elongation (approximate) (ASTM D882 using 0.5" x 0.10" [12.7 mm x 0.254 mm] samples)	90%					
Environmental Exposure (ASTM D638)	Ini	tial	30 Days		90 Days	
	Ultimate Tensile	Modulus	Ultimate Tensile	Modulus	Ultimate Tensile	Modulus
75°F Tap Water	5.95	76.0	5.15	83.0	3.99	73.0
120°F 100% R.H.	5.95	76.0	5.49	82.0	4.75	68.0
75°F Ethyl Gasoline	5.95	76.0	5.34	117.0	5.28	93.0
	*All values given in thousands of pounds per square inch (ksi)					
24°C Tap Water	4.1	52.4	3.5	57.2	2.7	50.3
49°C 100% R.H.	4.1	52.4	3.8	56.5	3.3	46.9
24°C Ethyl Gasoline	4.1	52.4	3.7	80.6	3.6	64.1
	*All value	s given in l	Megapasc	als (MPa)		

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III. Glass to Steel Bonds A. Tensile and Cleavage The following data shows typical values obtained with Scotch-Weld AF 42 on glass to steel bonds. Tensile values were measured on test plugs such as described in ASTM D1205 bonded to tempered safety glass. The surface of the test plugs and the glass were cleaned as outlined under the section on Product Application. A platen press with platen temperatures of 375°F (191°C) was used to produce a resultant bond line temperature of 350°F (177°C) with 50 psi (345 kPa) for 40 minutes. After removal from the press and cooling to ambient temperature, the bonds were conditioned as indicated and then pulled in an Instron Tensile Tester at a jaw separation of 0.05 inches/minute (1.27 mm/minute). **Average Values** Test **Test Temp** psi MPa 1. Tensile, Control -40°F (-40°C) 9200 63.4 75°F (24°C) 4000 27.6 200°F (93°C) 1710 11.8 75°F (24°C) 2. Tensile, 7 days Exposure to 4900 33.8 100% R.H. at 120°F 3. Tensile, after exposure to 75°F (24°C) 4100 28.2 5 cycles 200°F suddenly plunged into ice water at 32°F 4. Cleavage, Control -40°F (-40°C) 1300 9.0

B. Overlap Shear

The following data shows typical values obtained with Scotch-Weld AF 42 on glass to steel bonds in overlap shear. Values were measured on 1" (2.54 mm) wide strips of 20 gauge CRLCOH steel bonded to tempered safety glass. The surface of the steel and the glass were cleaned as outlined under the section on Product Application. A platen press set at the indicated temperature was used to bond one strip on each end of the glass.

75°F (24°C)

200°F (93°C)

720

400

5.0

2.8

			Average Values	
Test	Cure	Test Temp	psi	MPa
1. Overlap Shear, Control	40 min. @ 350°F (177°C), 50 psi (345 kPa)	75°F (24°C)	2400	16.5
2. Overlap Shear, Quick Cures	30 sec. @ 450°F (232°C), 50 psi (345 kPa) 60 sec. @ 450°F (232°C), 50 psi (345 kPa)	75°F (24°C) 75°F (24°C)	2760 3060	19.0 21.1
3. Overlap Shear, 7 days exposure to 100% R.H. at 120°F (49°C)	40 min. @ 350°F (177°C), 50 psi (345 kPa)	75°F (24°C)	2700	18.6
4. Overlap Shear, after exposure to 5 cycles, 200°F (93°C) suddenly plunged into ice water @ 32°F (0°C)	40 min. @ 350°F (177°C), 50 psi (345 kPa)	75°F (24°C)	2540	17.5

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III. Glass to Steel Bonds	C. Ultra-Violet Exposure							
(continued)	A 4" x 8" (101.6 mm x 203.2 mm) 20 gauge CRLCOH steel panel was polished with a 3M TM Scotch-Brite TM Scour Pad and bonded to tempered safety glass using Scotch-Weld AF 42. The assembly was bonded in a platen press @ 350°F (177°C) with 50 psi (345 kPa) for 40 minutes. A high degree of film clarity was apparent and good resolution of the detail on the metal was noted. It was exposed for 120 hours to an S-1 Sunlamp in accordance with ASTM D1148. No noticeable change was observed in the exposed areas.							
IV. Aluminum to Aluminum Bonds	The following product performance data has been obtained in the 3M Laboratory under the conditions specified. General application methods and bonding procedure are described later. All data reported in this section was developed under the							
	 following cure cycle: Cure Cycle - 50 psi (345 kPa) bonding pressure applied by a platen press at 10°F per minute bond temperature rise from 80°F to 350°F, with 60 ± 1 minute at 350°F ± 2°F (5.6°C per minute bond temperature rise from 27°C to 177°C, with 60 ± 1 minute at 177°C ± 1.1°C). 							
	A. Overlap Shear Bonds							
	The following data shows aluminum overlap panels overlap specimens cut fro 2024-T3 clad aluminum were tested per MIL-A-5 Original properties:	. Overlap shear om .063" x 4" x panels bonded	properties we 7" (1.6 mm x with AF 42 fil	ere measured o x 101.6 mm x 1	on 1" x 1/2" 177.8 mm)			
	Product	AF	42	AF	46			
		Ave	rage	Ave	rage			
	Test Temp	psi	MPa	psi	MPa			
	-67°F (-55°C	7295	50.3	5000	34.5			
	75°F (24°C)	5548	38.2	4000	27.6			
	180°F (82°C)	4535	31.2	2000	13.8			
	250°F (121°)	3010	20.7					

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IV. Aluminum to Aluminum Bonds (continued)

B. T-Peel Bonds

The following data shows typical values obtained with Scotch-Weld AF 42 in T-Peel. T-Peel bonds consist of 1" x 6" (25.4 mm x 152.4 mm) bonded areas of 2024-T3 clad 1" x 8" x .032" (25.4 mm x 203.2 mm x 0.8 mm) specimens with one layer of AF 42 film adhesive. Each metal skin of the T-Peel panels was pulled at a 90° angle to the bond line or 180° in relation to themselves. The jaw separation rate was 20" (508 mm) per minute.

Original Properties:

Product	AF 42 (3 mil)		AF 46	(1 mil)
	Average		Ave	rage
Test Temp	piw	N/25 mm	piw	N/25 mm
-67°F (-55°C	19	84.6	8	35.6
75°F (24°C)	75	333.8	40	178.0
180°F (82°C)	75	333.8	15	66.8

C. Cure Properties

Overlap Shear at 75°F (24°C)							
AF 42	350	°F (177°C) C	ure	450°F (232	°F (232°C) C	2°C) Cure	
(3 mil)	Time	psi	MPa	Time	psi	MPa	
	60 min	5822	40.1	5 min	6068	41.8	
	30 min	5234	36.1	4 min	6006	41.4	
	20 min	5654	39.0	3 min	5434	37.4	
	10 min	6872	47.3	2 min	5533	38.1	
	5 min	726	5.0	1 min	5290	36.4	
				30 sec	3293	22.7	

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Product Application		important as proper bond design and adhesive roperties. Improper adhesive application complete failure of an assembly.				
	conditions. The Product Performa developed using the following rec	Il give excellent properties under many application nce data reported in the previous section was ommended procedures. Variations from these be fully evaluated to insure bond properties s of user's particular assembly.				
	I. Surface Preparation					
	performance. Cleaning method surfaces are generally satisfact	ease-free surface is essential for maximum s which will produce a breakfree water film on metal ory. Surface preparation should be fully evaluated resistance to specific environments are anticipated.				
	A. Aluminum					
	8	te #164 solution (9-11 oz/gallon of water) at $.6^{\circ}$ C) for 15 ± 5 minutes. Rinse immediately in ming water.				
	2. Optimized FPL Etch Sol	Optimized FPL Etch Solution (1 liter):				
	Material Distilled Water Sodium Dichromate Sulfuric Acid Aluminum Chips	Amount 700 ml plus balance of liter (see below) 28 to 67.3 grams 287.9 to 310.0 grams 1.5 grams/liter of mixed solution				
	distilled water. Add sulfur to fill to 1 liter. Heat mixed 1.5 grams of 2024 bare alu	blution, dissolve sodium dichromate in 700 ml of ic acid and mix well. Add additional distilled water d solution to 150 to 160°F (66 to 71°C). Dissolve uminum chips per liter of mixed solution. Gentle um dissolve in about 24 hours.				
	To FPL etch panels, place 71°C) for 12 to 15 minutes	them in the above solution at 150 to 160° F (66 to s.				
		MSDS and other safety recommendations provided acturer prior to preparation of this etch solution.				
	3. Rinse – Rinse panels in cle	ear distilled, deionized or tap running water.				
	4. Dry – Air dry 15 minutes; maximum.	force dry 10 minutes minimum at 140°F (60°C)				
	B. Steel					
	1. Solvent wipe with alcohol	, acetone, MEK.*				
	 Polishing – Rub gently wi Wipe with solvent again. 	th 3M TM Scotch-Brite TM Scour Pad, if desired.				

*Note: Before using solvents, extinguish all ignition sources and follow the manufacturer's precautions and directions for use.

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Product Application (continued)	C. Glass						
(commueu)	1. Acid Clean – Place in sulfuric acid-sodium dichromate solution as described in section under Aluminum Preparation.						
	2. Rinse – Rinse panels in clear running water.						
	 Dry – Air dry 15 minutes; force dry 10 minutes minimum at 140°F (60°C) maximum. 						
	II. Adhesive Layup						
	Care should be taken to avoid contaminating adhesive and cleaned metal or glass by any substance which will hinder wetting action of film.						
	Film Application						
	1. Cut portion of film to be used from roll with protective liner in place.						
	2. Place film on metal using the separating liner as a protective cover.						
	3. Remove protective liner.						
	4. Assemble parts and cure.						
	III. Standard Cure Cycle						
	The following cure cycle envelope is recommended to obtain dense glue lines:						
	Press Cure Cycle						
	 Apply a pressure of 50 psi (345 kPa) prior to reaching a bond line temperature of 150°F (66°C) and maintain throughout the press cure cycle. 						
	2. Raise the bond line temperature from ambient to 330-350°F (166-177°C) at a rate of 10°F (5.6°C) per minute.						
	3. Cure for 30-60 minutes at 330-350°F (166-177°C).						
	 Cool to below 200°F (93°C) bond line temperature prior to release of pressure. 						
	IV. Effect of Cure Cycle Variations on Performance						
	In addition to the standard cure cycle, Scotch-Weld AF 42 exhibits broad capabilities to accommodate many types of existing Structural Adhesive Bonding Equipment and still produce excellent strength bonds. However, temperatures of 330°F (166°C) are minimum cure conditions.						
Storage Stability	Storage at $40^{\circ}F(4^{\circ}C)$ or lower is recommended for Scotch-Weld AF 42 and AF 46 to obtain maximum shelf life.						
	3M Standard Shelf Life for Scotch-Weld AF 42 is 15 months from date of shipment from 3M when stored at 40° F (4° C) or below.						
	3M Standard Shelf Life for Scotch-Weld AF 46 is 6 months from date of shipment from 3M when stored at 40°F (4°C) or below.						

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Precautionary Information	Refer to Product Label and Material Safety Data Sheet for health and safety information before using this product.
For Additional Information	To request additional product information or to arrange for sales assistance, call toll free (800) 235-2376. Our fax number is (417) 869-5219. Address correspondence to: 3M Aerospace Central, 3211 E. Chestnut Expressway, Springfield, MO 65802.
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